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BGU7062

Analog high linearity low noise variable gain amplifier

Rev. 1 — 10 August 2012

Preliminary data sheet

1. Product profile

1.1 General description

The BGU7062 is a fully integrated analog-controlled variable gain amplifier module. Its low noise and high linearity performance makes it ideal for sensitive receivers in cellular base station applications. The BGU7062 is operating in the 1710 MHz to 1785 MHz frequency range and has a gain control range of 35 dB. At maximum gain the noise figure is 0.85 dB. The gain is analog-controlled having maximum gain at 0 V and minimum gain at 3.3 V. The LNA can be bypassed extending the dynamic range. The BGU7062 is internally matched to 50 ohm, meaning no external matching is required, enabling ease of use. It is housed in a 16 pins 8 mm \times 8 mm \times 1.3 mm leadless HLQFN16R package SOT1301.

1.2 Features and benefits

- Input and output internally matched to 50 Ω
- Low noise figure of 0.85 dB
- High input IP3 of 0.8 dBm
- High P_{i(1dB)} of –12.8 dBm
- Bypass mode of LNA giving high dynamic gain range
- Gain control range of 0 dB to 35 dB
- Single 5 V supply
- Single analog gain control of 0 V to 3.3 V
- Unconditionally stable up to 12.75 GHz
- Moisture sensitivity level 3
- ESD protection at all pins

1.3 Applications

- Cellular base stations, remote radio heads
- 3G, LTE infrastructure
- Low noise applications with variable gain and high linearity requirements
- Active antenna



Analog high linearity low noise variable gain amplifier

1.4 Quick reference data

Table 1. Quick reference data

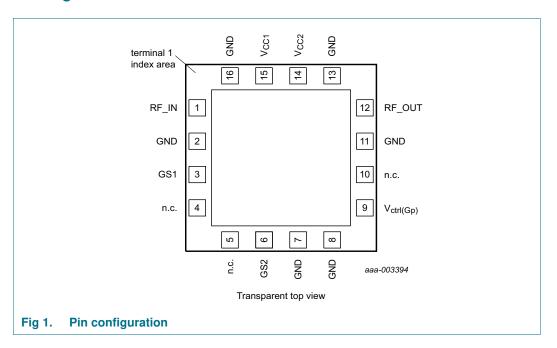
 V_{CC1} = 5 V; V_{CC2} = 5 V; f = 1750 MHz; T_{amb} = 25 °C; input and output 50 Ω ; unless otherwise specified.

| Symbol | Parameter | Conditions | | Min | Тур | Max | Unit |
|---------------------|--------------------------------------|--|------------|-----|-------|-----|------|
| $I_{CC(tot)}$ | total supply current | high gain mode | <u>[1]</u> | 190 | 220 | 250 | mA |
| | | low gain mode | [2] | 165 | 190 | 215 | mA |
| NF | noise figure | $V_{ctrl(Gp)} = 0 V $ (maximum power gain) | [1] | - | 0.85 | - | dB |
| | | $G_p = 35 \text{ dB}$ | [1] | - | 0.95 | 1.1 | dB |
| IP3 _I | input third-order intercept point | $G_p = 35 \text{ dB}$; 2-tone; tone-spacing = 1.0 MHz | [1] | 0 | 8.0 | - | dBm |
| P _{i(1dB)} | input power at 1 dB gain compression | $G_p = 35 \text{ dB}$ | [1] | -14 | -12.8 | - | dBm |

^[1] high gain mode: GS1 = LOW; GS2 = HIGH (see Table 9)

2. Pinning information

2.1 Pinning



2.2 Pin description

Table 2. Pin description

| Symbol | Pin | Description |
|--------|---------------------|-----------------------|
| RF_IN | 1 | RF input |
| GND | 2, 7, 8, 11, 13, 16 | ground |
| GS1 | 3 | gain switch control 1 |
| n.c. | 4, 5, 10 | not connected |
| GS2 | 6 | gain switch control 2 |

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^[2] low gain mode: GS1 = HIGH; GS2 = LOW (see Table 9)

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 Table 2.
 Pin description ...continued

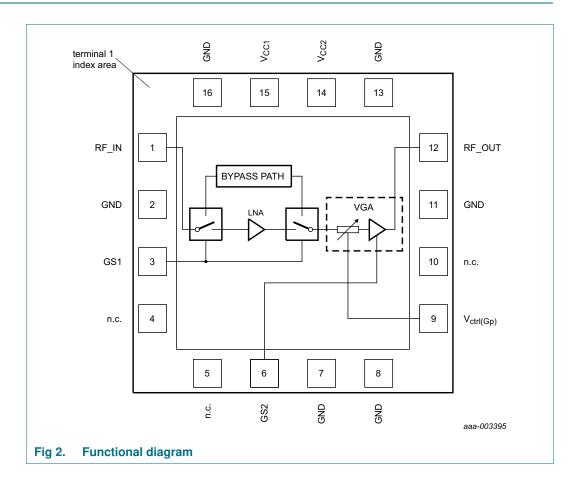
| Symbol | Pin | Description |
|-----------------------|-----|----------------------------|
| V _{ctrl(Gp)} | 9 | power gain control voltage |
| RF_OUT | 12 | RF output |
| V _{CC2} | 14 | supply voltage 2 |
| V _{CC1} | 15 | supply voltage 1 |

3. Ordering information

Table 3. Ordering information

| Type number | Package | | | | | | |
|-------------|----------|---|-----------|--|--|--|--|
| | Name | Description | Version | | | | |
| BGU7062 | HLQFN16R | plastic thermal enhanced low quad flat package; no leads; 16 terminals; body $8\times8\times1.3$ mm | SOT1301-1 | | | | |

4. Functional diagram



Analog high linearity low noise variable gain amplifier

5. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

| Symbol | Parameter | Conditions | | Min | Max | Unit |
|-----------------------|------------------------------------|---|-----|-----|------|------|
| V_{CC} | supply voltage | | | 0 | 6 | V |
| $V_{\text{ctrl}(Gp)}$ | power gain control voltage | | | -1 | +3.6 | V |
| $V_{I(GS1)}$ | input voltage on pin GS1 | | | -1 | +3.6 | V |
| $V_{I(GS2)}$ | input voltage on pin GS2 | | | -1 | +3.6 | V |
| $P_{i(RF)CW} \\$ | continuous waveform RF input power | high gain mode; $V_{ctrl(Gp)} = 0 V$ | [1] | - | 10 | dBm |
| | | low gain mode; $V_{ctrl(Gp)} = 0 V$ | [2] | - | 15 | dBm |
| Tj | junction temperature | | | - | 150 | °C |
| T _{stg} | storage temperature | | | -40 | +150 | °C |
| V _{ESD} | electrostatic discharge voltage | Human Body Model (HBM); according to ANSI/ESDA-JEDEC JS-001-2020-Device Testing, Human Body Model | | - | ±2 | kV |
| | | Charged Device Model (CDM); according to JEDEC standard 22-C101 | | - | ±750 | V |

^[1] high gain mode: GS1 = LOW; GS2 = HIGH (see Table 9)

6. Recommended operating conditions

Table 5. Recommended operating conditions

| Symbol | Parameter | Conditions | Min | Тур | Max | Unit |
|-----------------------|----------------------------|------------|------|-----|------|------|
| V _{CC1} | supply voltage 1 | | 4.75 | 5 | 5.25 | V |
| V _{CC2} | supply voltage 2 | | 4.75 | 5 | 5.25 | V |
| V _{ctrl(Gp)} | power gain control voltage | | 0 | - | 3.3 | V |
| V _{I(GS1)} | input voltage on pin GS1 | | 0 | - | 3.3 | V |
| V _{I(GS2)} | input voltage on pin GS2 | | 0 | - | 3.3 | V |
| Z ₀ | characteristic impedance | | - | 50 | - | Ω |
| T _{case} | case temperature | | -40 | - | +85 | °C |

7. Thermal characteristics

Table 6. Thermal characteristics

| Symbol | Parameter | Conditions | Тур | Unit |
|-------------------------|--|------------|--------------|------|
| $R_{th(j\text{-case})}$ | thermal resistance from junction to case | | <u>11</u> 42 | K/W |

^[1] The case temperature is measured at the ground solder pad.

^[2] low gain mode: GS1 = HIGH; GS2 = LOW (see Table 9)

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8. Characteristics

Table 7. Characteristics high gain mode

GS1 = LOW; GS2 = HIGH (see <u>Table 9</u>); V_{CC1} = 5 V; V_{CC2} = 5 V; f = 1750 MHz; T_{amb} = 25 °C; input and output 50 Ω ; unless otherwise specified. All RF parameters have been characterized at the device RF input and RF output terminals.

| Symbol | Parameter | Conditions | Min | Тур | Max | Unit |
|----------------------|--------------------------------------|--|-----|-------|-----|------|
| $I_{CC(tot)}$ | total supply current | | 190 | 220 | 250 | mA |
| G _{p(min)} | minimum power gain | $V_{ctrl(Gp)} = 3.3 \text{ V}$ | - | 13.5 | - | dB |
| G _{p(max)} | maximum power gain | $V_{ctrl(Gp)} = 0 V$ | - | 37 | - | dB |
| G _{p(flat)} | power gain flatness | $1710~MHz \leq f \leq 1785~MHz;~18~dB \leq G_p \leq 35~dB$ | - | 0.3 | - | dB |
| NF | noise figure | $V_{ctrl(Gp)} = 0 V $ (maximum power gain) | - | 0.85 | - | dB |
| | | $G_p = 35 \text{ dB}$ | - | 0.95 | 1.1 | dB |
| | | $G_p = 18 \text{ dB}$ | - | 5.80 | - | dB |
| IP3 _I | input third-order intercept point | 2-tone; tone-spacing = 1.0 MHz | | | | |
| | | $G_p = 35 \text{ dB}$ | 0 | 0.8 | - | dBm |
| | | $G_p = 30 \text{ dB}$ | - | 3.2 | - | dBm |
| | | $G_p = 29 \text{ dB}$ | - | 3.5 | - | dBm |
| | | G _p = 18 dB | - | 5.0 | - | dBm |
| P _{i(1dB)} | input power at 1 dB gain compression | $G_p = 35 \text{ dB}$ | -14 | -12.8 | - | dBm |
| | | $G_p = 30 \text{ dB}$ | - | -7.5 | - | dBm |
| | | $G_p = 29 \text{ dB}$ | - | -7.0 | - | dBm |
| | | $G_p = 18 \text{ dB}$ | - | -5.9 | - | dBm |
| RLin | input return loss | V _{ctrl(Gp)} = 0 V (maximum power gain) | - | 30 | - | dB |
| | | $G_p = 35 \text{ dB}$ | - | 25 | - | dB |
| RLout | output return loss | V _{ctrl(Gp)} = 0 V (maximum power gain) | - | 17 | - | dB |
| K | Rollett stability factor | $0 \text{ GHz} \le f \le 12.75 \text{ GHz}$ | 1 | - | - | |

Table 8. Characteristics low gain mode

GS1 = HIGH; GS2 = LOW (see <u>Table 9</u>); $V_{CC1} = 5$ V; $V_{CC2} = 5$ V; f = 1750 MHz; $T_{amb} = 25$ °C; input and output 50 Ω ; unless otherwise specified. All RF parameters have been characterized at the device RF input and RF output terminals.

| Symbol | Parameter | Conditions | Min | Тур | Max | Unit |
|----------------------|-----------------------------------|---|-----|------|-----|------|
| I _{CC(tot)} | total supply current | | 165 | 190 | 215 | mA |
| G _{p(min)} | minimum power gain | $V_{ctrl(Gp)} = 3.3 \text{ V}$ | - | -6.6 | - | dB |
| $G_{p(max)}$ | maximum power gain | $V_{ctrl(Gp)} = 0 V$ | - | 18.6 | - | dB |
| $G_{p(flat)}$ | power gain flatness | 1710 MHz \leq f \leq 1785 MHz; 3 dB \leq G_p \leq 17 dB | - | 0.1 | - | dB |
| NF | noise figure | $G_p = 17 \text{ dB}$ | - | 9.8 | - | dB |
| | | $G_p = 3 dB$ | - | 20.6 | - | dB |
| IP3 _I | input third-order intercept point | 2-tone; tone-spacing = 1.0 MHz | | | - | |
| | | $G_p = 17 dB$ | - | 20 | - | dBm |
| | | $G_p = 12 dB$ | - | 24 | - | dBm |
| | | $G_p = 11 dB$ | - | 25 | - | dBm |
| | | $G_p = 3 dB$ | - | 28 | - | dBm |

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 Table 8.
 Characteristics low gain mode ...continued

GS1 = HIGH; GS2 = LOW (see <u>Table 9</u>); V_{CC1} = 5 V; V_{CC2} = 5 V; f = 1750 MHz; T_{amb} = 25 °C; input and output 50 Ω ; unless otherwise specified. All RF parameters have been characterized at the device RF input and RF output terminals.

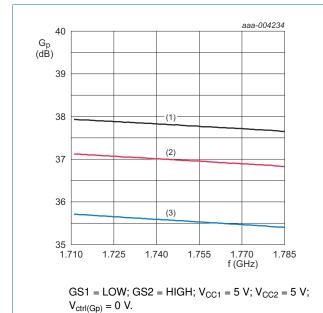
| | • | • | | • | | |
|-----------------|--------------------------------------|--|-----|------|-----|------|
| Symbol | Parameter | Conditions | Min | Тур | Max | Unit |
| $P_{i(1dB)} \\$ | input power at 1 dB gain compression | $G_p = 17 dB$ | - | 6.0 | - | dBm |
| | | $G_p = 12 \text{ dB}$ | - | 10.0 | - | dBm |
| | | $G_p = 11 \text{ dB}$ | - | 10.5 | - | dBm |
| | | $G_p = 3 dB$ | - | 10.5 | - | dBm |
| RL_{in} | input return loss | $V_{ctrl(Gp)} = 0 V $ (maximum power gain) | - | 30 | - | dB |
| | | $G_p = 17 \text{ dB}$ | - | 25 | - | dB |
| RLout | output return loss | $V_{ctrl(Gp)} = 0 V $ (maximum power gain) | - | 18 | - | dB |
| K | Rollett stability factor | 0 GHz ≤ f ≤ 12.75 GHz | 1 | - | - | |

Table 9. Gain switch truth table

 $V_{CC1} = 5 \text{ V}; V_{CC2} = 5 \text{ V}; -10 \text{ }^{\circ}\text{C} \leq T_{amb} \leq +85 \text{ }^{\circ}\text{C}$

| Gain mode | GS1 | | GS2 | | | |
|----------------|-------|------------------|-------|------------------|--|--|
| | logic | V _{GS1} | logic | V _{GS2} | | |
| high gain mode | LOW | 0 V to 0.5 V | HIGH | 2 V to 3.3 V | | |
| low gain mode | HIGH | 2 V to 3.3 V | LOW | 0 V to 0.5 V | | |

8.1 Graphs

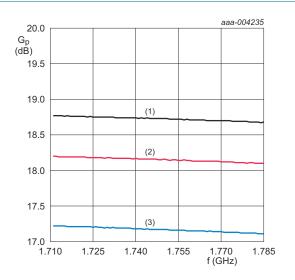


(1) $T_{amb} = -10 \, ^{\circ}C$

(2) $T_{amb} = +25 \, ^{\circ}C$

(3) $T_{amb} = +85 \, ^{\circ}C$

Fig 3. Power gain as a function of frequency in high gain mode; typical values



 $GS1 = HIGH; GS2 = LOW; V_{CC1} = 5 V; V_{CC2} = 5 V; V_{ctrl(Gp)} = 0 V.$

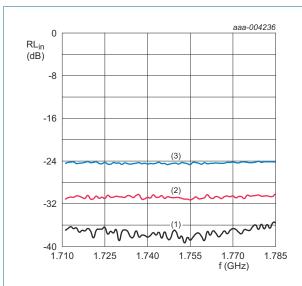
(1) $T_{amb} = -10 \, ^{\circ}C$

(2) $T_{amb} = +25 \, ^{\circ}C$

(3) $T_{amb} = +85 \, ^{\circ}C$

Fig 4. Power gain as a function of frequency in low gain mode; typical values

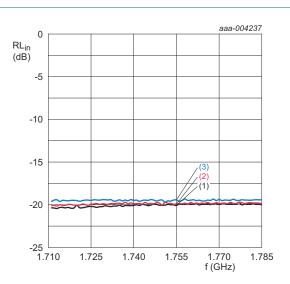
Analog high linearity low noise variable gain amplifier



GS1 = LOW; GS2 = HIGH; V_{CC1} = 5 V; V_{CC2} = 5 V; $V_{ctrl(GD)}$ = 0 V.

- (1) $T_{amb} = -10 \, ^{\circ}C$
- (2) $T_{amb} = +25 \, ^{\circ}C$
- (3) $T_{amb} = +85 \, ^{\circ}C$

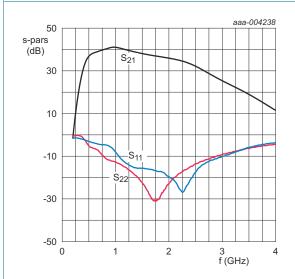
Fig 5. Input return loss as a function of frequency in high gain mode; typical values



GS1 = HIGH; GS2 = LOW; V_{CC1} = 5 V; V_{CC2} = 5 V; $V_{ctrl(Gp)}$ = 0 V.

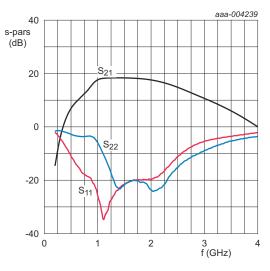
- (1) $T_{amb} = -10 \, ^{\circ}C$
- (2) $T_{amb} = +25 \, ^{\circ}C$
- (3) $T_{amb} = +85 \, ^{\circ}C$

Fig 6. Input return loss as a function of frequency in low gain mode; typical values



GS1 = LOW; GS2 = HIGH; V_{CC1} = 5 V; V_{CC2} = 5 V; $V_{ctrl(Gp)}$ = 0 V; T_{amb} = 25 °C.

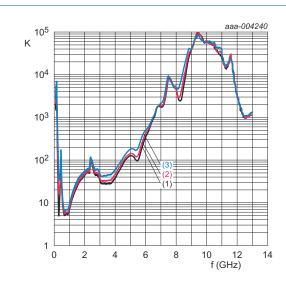
Fig 7. S-parameters as a function of frequency in high gain mode; typical values



 $GS1 = HIGH; GS2 = LOW; V_{CC1} = 5 V; V_{CC2} = 5 V; V_{ctrl(Gp)} = 0 V; T_{amb} = 25 \, ^{\circ}C.$

Fig 8. S-parameters as a function of frequency in low gain mode; typical values

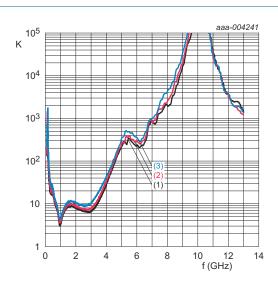
Analog high linearity low noise variable gain amplifier



GS1 = LOW; GS2 = HIGH; V_{CC1} = 5 V; V_{CC2} = 5 V; $V_{ctrl(GD)}$ = 0 V.

- (1) $T_{amb} = -10 \, ^{\circ}C$
- (2) $T_{amb} = +25 \, ^{\circ}C$
- (3) $T_{amb} = +85 \, ^{\circ}C$

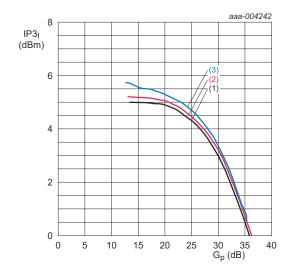
Fig 9. Rollet stability factor as a function of frequency in high gain mode; typical values



GS1 = HIGH; GS2 = LOW; V_{CC1} = 5 V; V_{CC2} = 5 V; $V_{ctrl(Gp)}$ = 0 V.

- (1) $T_{amb} = -10 \, ^{\circ}C$
- (2) $T_{amb} = +25 \, ^{\circ}C$
- (3) $T_{amb} = +85 \, ^{\circ}C$

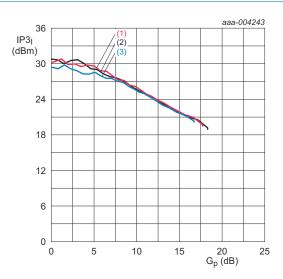
Fig 10. Rollet stability factor as a function of frequency in low gain mode; typical values



GS1 = LOW; GS2 = HIGH; $V_{CC1} = 5 \text{ V}$; $V_{CC2} = 5 \text{ V}$; f = 1750 MHz.

- (1) $T_{amb} = -10 \, ^{\circ}C$
- (2) $T_{amb} = +25 \, ^{\circ}C$
- (3) $T_{amb} = +85 \, ^{\circ}C$

Fig 11. Input third-order intercept point as a function of power gain in high gain mode; typical values

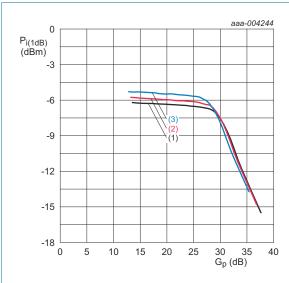


GS1 = HIGH; GS2 = LOW; V_{CC1} = 5 V; V_{CC2} = 5 V; f = 1750 MHz.

- (1) $T_{amb} = -10 \, ^{\circ}C$
- (2) $T_{amb} = +25 \, ^{\circ}C$
- (3) $T_{amb} = +85 \, ^{\circ}C$

Fig 12. Input third-order intercept point as a function of power gain in low gain mode; typical values

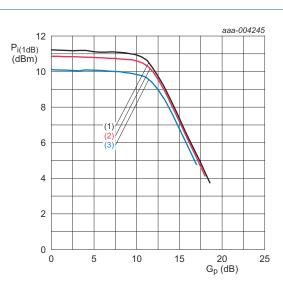
Analog high linearity low noise variable gain amplifier



GS1 = LOW; GS2 = HIGH; V_{CC1} = 5 V; V_{CC2} = 5 V; f = 1750 MHz.

- (1) $T_{amb} = -10 \, ^{\circ}C$
- (2) $T_{amb} = +25 \, ^{\circ}C$
- (3) $T_{amb} = +85 \, ^{\circ}C$

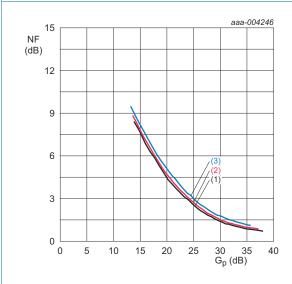
Fig 13. Input power at 1 dB gain compression as a function of power gain in high gain mode; typical values



GS1 = HIGH; GS2 = LOW; V_{CC1} = 5 V; V_{CC2} = 5 V; f = 1750 MHz.

- (1) $T_{amb} = -10 \, ^{\circ}C$
- (2) $T_{amb} = +25 \, ^{\circ}C$
- (3) $T_{amb} = +85 \, ^{\circ}C$

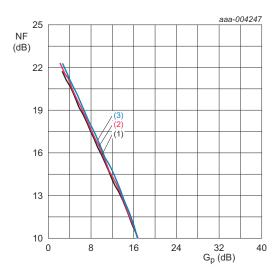
Fig 14. Input power at 1 dB gain compression as a function of power gain in low gain mode; typical values



GS1 = LOW; GS2 = HIGH; V_{CC1} = 5 V; V_{CC2} = 5 V; f = 1750 MHz.

- (1) $T_{amb} = -10 \, ^{\circ}C$
- (2) $T_{amb} = +25 \, ^{\circ}C$
- (3) $T_{amb} = +85 \, ^{\circ}C$

Fig 15. Noise figure as a function of power gain in high gain mode; typical values

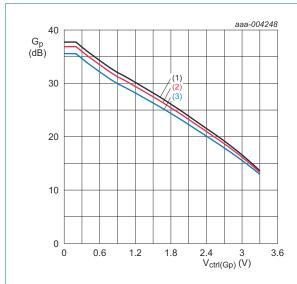


GS1 = HIGH; GS2 = LOW; V_{CC1} = 5 V; V_{CC2} = 5 V; f = 1750 MHz.

- (1) $T_{amb} = -10 \, ^{\circ}C$
- (2) $T_{amb} = +25 \, ^{\circ}C$
- (3) $T_{amb} = +85 \, ^{\circ}C$

Fig 16. Noise figure as a function of power gain in low gain mode; typical values

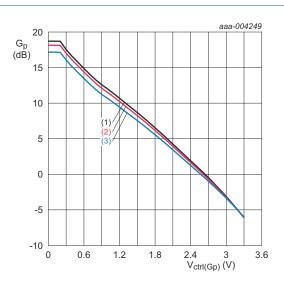
Analog high linearity low noise variable gain amplifier



GS1 = LOW; GS2 = HIGH; V_{CC1} = 5 V; V_{CC2} = 5 V; f = 1750 MHz.

- (1) $T_{amb} = -10 \, ^{\circ}C$
- (2) $T_{amb} = +25 \, ^{\circ}C$
- (3) $T_{amb} = +85 \, ^{\circ}C$

Fig 17. Power gain as a function of power gain control voltage in high gain mode; typical values



GS1 = HIGH; GS2 = LOW; V_{CC1} = 5 V; V_{CC2} = 5 V; f = 1750 MHz.

- (1) $T_{amb} = -10 \, ^{\circ}C$
- (2) $T_{amb} = +25 \, ^{\circ}C$
- (3) $T_{amb} = +85 \, ^{\circ}C$

Fig 18. Power gain as a function of power gain control voltage in low gain mode; typical values

9. Application information

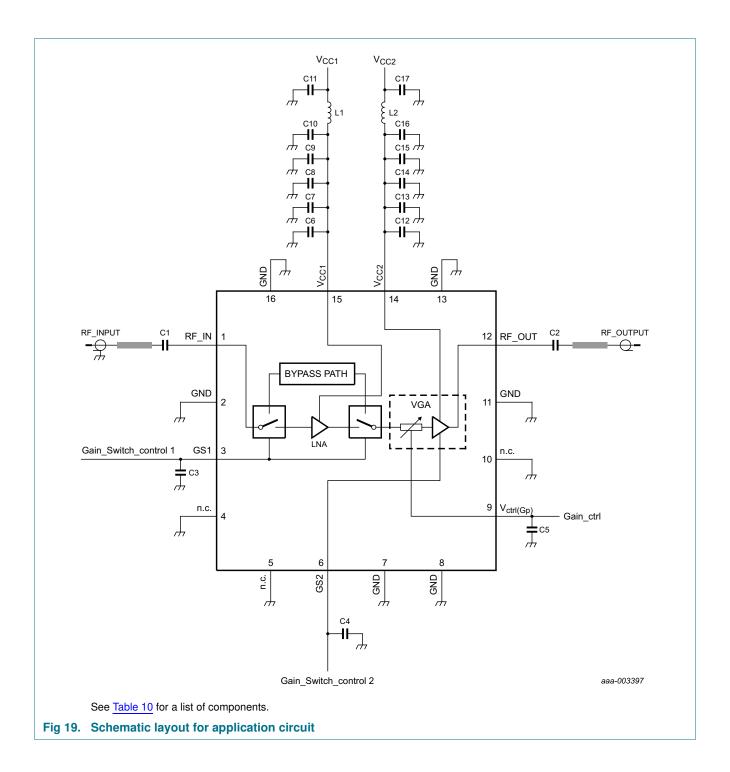
Table 10. List of components For application circuit see Figure 19.

| Component | Description | Value | | Remarks |
|---------------------|-------------|----------|-----|---------|
| C1, C2 | capacitor | 1 nF | [1] | 0402 |
| C3, C4, C5, C6, C12 | capacitor | 100 pF | [1] | 0402 |
| C7, C8, C9, C10, | capacitor | optional | | |
| C11, C17 | capacitor | 100 nF | [1] | 0402 |
| C13, C14, C15, C16 | capacitor | optional | | |
| L1, L2 | inductor | 10 nH | [2] | 0402 |

^[1] Murata GRM1555 series.

^[2] Murata LQG15 series.

Analog high linearity low noise variable gain amplifier



Analog high linearity low noise variable gain amplifier

10. Package outline

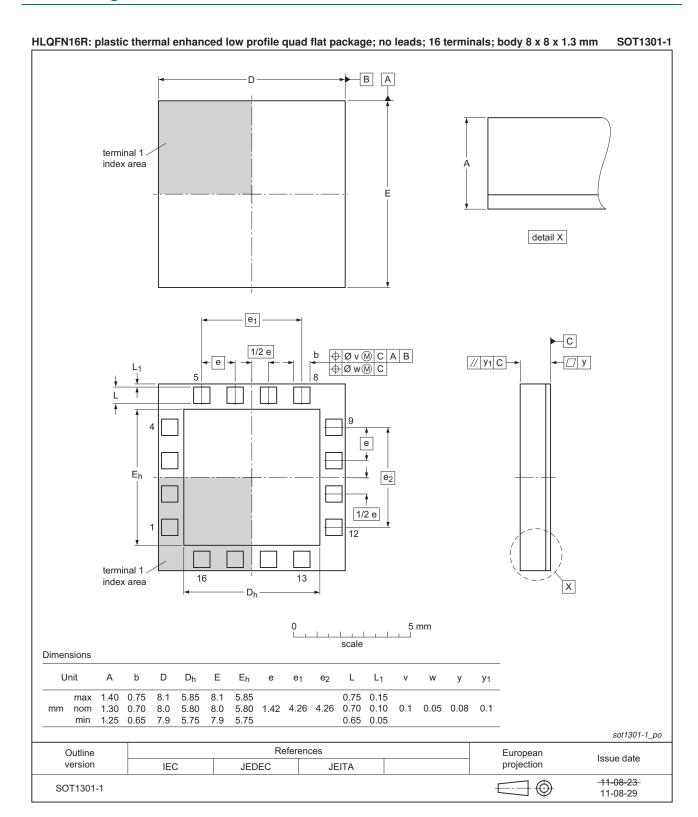


Fig 20. Package outline SOT1301-1 (HLQFN16R)

Analog high linearity low noise variable gain amplifier

11. Abbreviations

Table 11. Abbreviations

| Acronym | Description |
|---------|-------------------------|
| 3G | 3rd Generation |
| ESD | ElectroStatic Discharge |
| LNA | Low Noise Amplifier |
| LTE | Long Term Evolution |

12. Revision history

Table 12. Revision history

| Document ID | Release date | Data sheet status | Change notice | Supersedes |
|-------------|--------------|------------------------|---------------|------------|
| BGU7062 v.1 | 20120810 | Preliminary data sheet | - | - |

Analog high linearity low noise variable gain amplifier

13. Legal information

13.1 Data sheet status

| Document status[1][2] | Product status[3] | Definition |
|--------------------------------|-------------------|---|
| Objective [short] data sheet | Development | This document contains data from the objective specification for product development. |
| Preliminary [short] data sheet | Qualification | This document contains data from the preliminary specification. |
| Product [short] data sheet | Production | This document contains the product specification. |

- [1] Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions"
- [3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL http://www.nxp.com.

13.2 Definitions

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Analog high linearity low noise variable gain amplifier

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